

T-1 (3mm) RIGHT ANGLE LED INDICATOR

Green

Part Number: WP934EW/GD

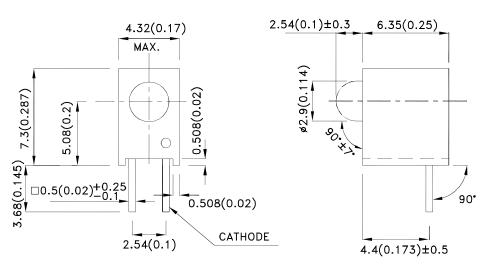
Features

- Pre-trimmed leads for pc mounting.
- Black case enhances contrast ratio.
- High reliability life measured in years.
- Housing UL rating:94V-0.
- Housing material: type 66 nylon.
- RoHS compliant.

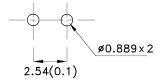
Description

The Green source color devices are made with Gallium Phosphide Green Light Emitting Diode.

Package Dimensions









- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is ±0.25(0.01") unless otherwise noted.
- Lead spacing is measured where the leads emerge from the package.
 The specifications, characteristics and technical data described in the datasheet are subject to change without prior notice.

SPEC NO: DSAF1855 **REV NO: V.9B DATE: APR/13/2015** PAGE: 1 OF 5 **APPROVED: WYNEC CHECKED: Allen Liu** DRAWN: Q.M.Chen ERP: 1102013066

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Selection Guide

Part No.	Dice	lv (mcd) [2] Dice Lens Type @ 10mA		,	Viewing Angle [1]
		2.	Min.	Тур.	201/2
WP934EW/GD	Green (GaP)	Green Diffused	10	25	40°

- 1. θ 1 / 2 is the angle from optical centerline where the luminous intensity is 1 / 2 of the optical peak value.
- Luminous intensity / luminous Flux: + / -15%.
 Luminous intensity value is traceable to the CIE127-2007 compliant national standards.

Electrical / Optical Characteristics at TA=25°C

Symbol	Parameter	Device	Тур.	Max.	Units	Test Conditions
λpeak	Peak Wavelength	Green	565		nm	IF=20mA
λD [1]	Dominant Wavelength	Green	568		nm	IF=20mA
Δλ1/2	Spectral Line Half-width	Green	30		nm	IF=20mA
С	Capacitance	Green	15		pF	VF=0V;f=1MHz
VF [2]	Forward Voltage	Green	2.2	2.5	V	IF=20mA
lr	Reverse Current	Green		10	uA	VR = 5V

Notes:

- 1. Wavelength: + / -1nm.
- 2. Forward Voltage: + / -0.1V.
- 3. Wavelength value is traceable to the CIE127-2007 compliant national standards.
- 4. Excess driving current and / or operating temperature higher than recommended conditions may result in severe light degradation or premature failure.

Absolute Maximum Ratings at TA=25°C

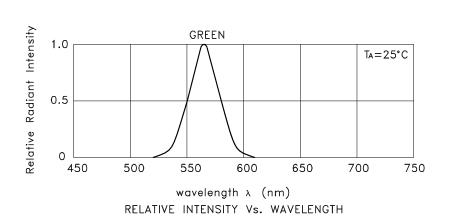
Parameter	Green	Units	
Power dissipation	62.5	mW	
DC Forward Current	25	mA	
Peak Forward Current [1]	140	mA	
Reverse Voltage	5	V	
Operating/Storage Temperature	-40°C To +85°C		
Lead Solder Temperature [2]	260°C For 3 Seconds		
Lead Solder Temperature [3]	260°C For 5 Seconds		

Notes:

- 1. 1 / 10 Duty Cycle, 0.1ms Pulse Width.
- 2. 2mm below package base.
- 3. 5mm below package base.

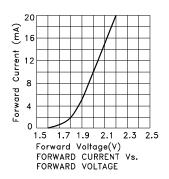
SPEC NO: DSAF1855 REV NO: V.9B DATE: APR/13/2015 PAGE: 2 OF 5 APPROVED: WYNEC **CHECKED: Allen Liu** DRAWN: Q.M.Chen ERP: 1102013066

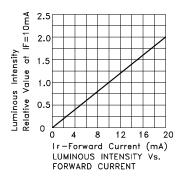
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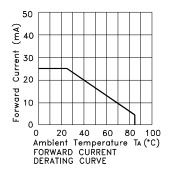


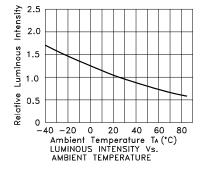
Green

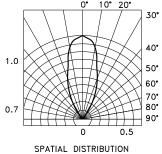
WP934EW/GD







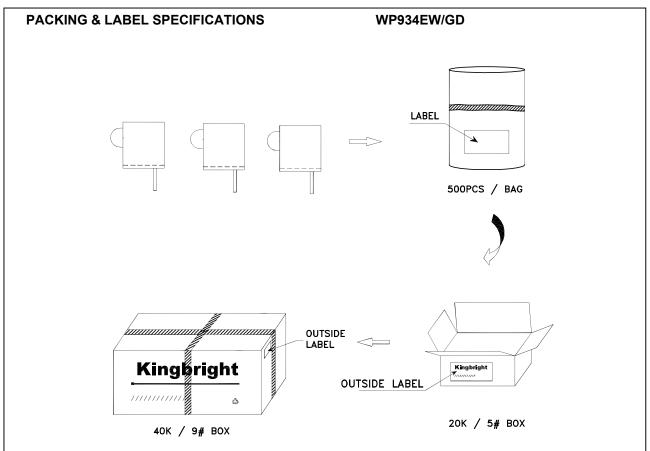




SPEC NO: DSAF1855 REV NO: V.9B
APPROVED: WYNEC CHECKED: Allen Liu

DATE: APR/13/2015 DRAWN: Q.M.Chen PAGE: 3 OF 5 ERP: 1102013066







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 SPEC NO: DSAF1855
 REV NO: V.9B
 DATE: APR/13/2015
 PAGE: 4 OF 5

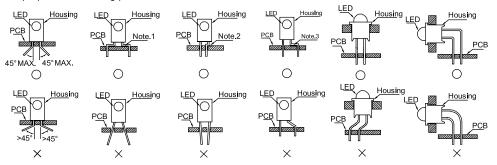
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PRECAUTIONS

- 1. Storage conditions:
 - a. Avoid continued exposure to the condensing moisture environment and keep the product away from rapid transitions in ambient temperature.
 - b.LEDs should be stored with temperature \leq 30° C and relative humidity < 60%.
 - c.Product in the original sealed package is recommended to be assembled within 72 hours of opening.

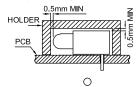
 Product in opened package for more than a week should be baked for 30 (+10/-0) hours at 85 ~ 100°C.
- 2. The lead pitch of the LED must match the pitch of the mounting holes on the PCB during component placement. Lead-forming may be required to insure the lead pitch matches the hole pitch. Refer to the figure below for proper lead forming procedures.

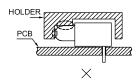


" \bigcirc " Correct mounting method " imes " Incorrect mounting method

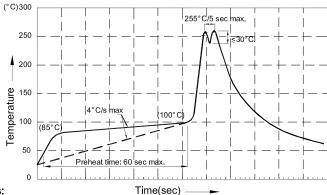
Note 1-3: Do not route PCB trace in the contact area between the leadframe and the PCB to prevent short-circuits.

During soldering, component covers and holders should leave clearance to avoid placing damaging stress on the LED during soldering.





- 4. The tip of the soldering iron should never touch the lens epoxy.
- 5. Through-hole LEDs are incompatible with reflow soldering.
- If the LED will undergo multiple soldering passes or face other processes where the part may be subjected to intense heat, please check with Kingbright for compatibility.
- 7. Recommended Wave Soldering Profiles:



Notes:

- 1.Recommend pre-heat temperature of 105° C or less (as measured with a thermocouple attached to the LED pins) prior to immersion in the solder wave with a maximum solder bath temperature of 260° C
- 2.Peak wave soldering temperature between 245°C ~ 255°C for 3 sec (5 sec max).
- 3.Do not apply stress to the epoxy resin while the temperature is above 85°C.
- 4. Fixtures should not incur stress on the component when mounting and during soldering process.
- 5.SAC 305 solder alloy is recommended.
- 6.No more than one wave soldering pass.

SPEC NO: DSAF1855 REV NO: V.9B DATE: APR/13/2015 PAGE: 5 OF 5
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AMEYA360 Components Supply Platform

Authorized Distribution Brand:

























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